











PRODUCT DATASHEET



- ► PCB / CHIP LED
- ▶ 0805 (1.1t)
- ➤ Yellow (590nm)

N0Y10S46





0805 1.1t Series

APPLICATIONS:

- Backlighting
- Indication Light
- Switch light
- Dashboard

0805 1.1t Series





FEATURES:

Package: PCB / CHIP LED
 Forward Current: 20mA
 Forward Voltage (typ.): 2.1V

• Luminous Intensity (typ.): 150mcd @20mA

Colour: YellowWavelength: 590nmViewing angle: 140°

Materials:

Die: AlGaInP/GaAs

Resin: Epoxy (Water Clear)
 Operating Temperature: -40~+80°C
 Storage Temperature: -40~+85°C

• Grouping parameters:

Forward voltage

Luminous intensity

Dominant wavelength

Soldering methods: Reflow

• Preconditioning: acc. to JEDEC Level 3

• Packing: 8mm tape with 3000/reel, ø180mm (7")



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	30	mA
Peak Forward Current Duty 1/8@1KHz	I _{FP}	125	mA
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	PD	75	mW
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+85	°C

Electrical & Optical Characteristics (Ta=25°C)

Darameter	Cumbal	Values			l loit	Test
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V_{F}	1.7	2.1	2.5	V	I _F =20mA
Luminous Intensity	I _V	80	150	230	mcd	I _F =20mA
Dominant Wavelength	$\lambda_{\scriptscriptstyle D}$	585	590	595	nm	I _F =20mA
Peak Wavelength	$\lambda_{ extsf{P}}$		595		nm	I _F =20mA
Spectral Line Half Bandwidth	Δλ		17		nm	I _F =20mA
Viewing Angle	2θ _{1/2}		140		deg	I _F =20mA

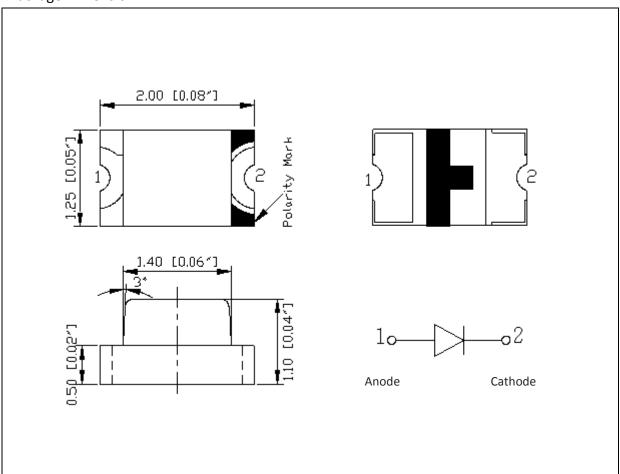
^{1.} Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V, Viewing angle(2 $\theta_{1/2}$) ±5%

^{2.} IS standard testing



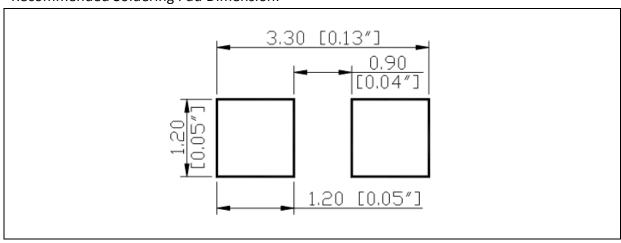
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
D	1.7	2.5	V

Luminous Intensity Classifications (I_F = 20mA):

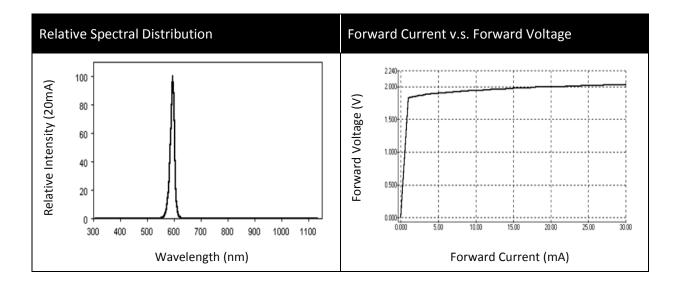
Code	Min.	Max.	Unit
I	80	100	
J	100	125	
К	125	160	mcd
L	160	200	
M	200	250	

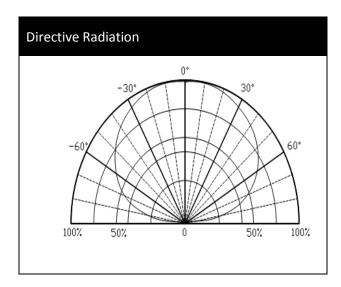
Dominant Wavelength Classifications ($I_F = 20$ mA):

Code	Min.	Max.	Unit	
M	585	590		
N	590	595	nm	



ELECTRO-OPTICAL CHARACTERISTICS:



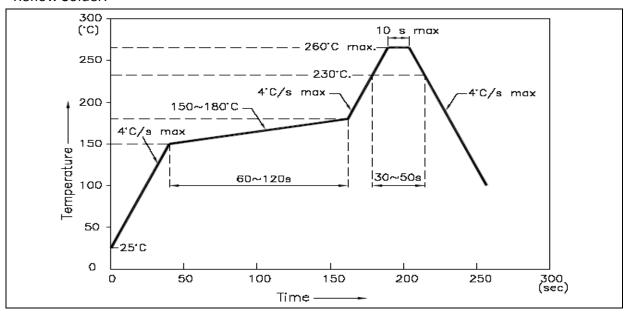


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RECOMMENDED SOLDERING PROFILE:

Reflow Solder:



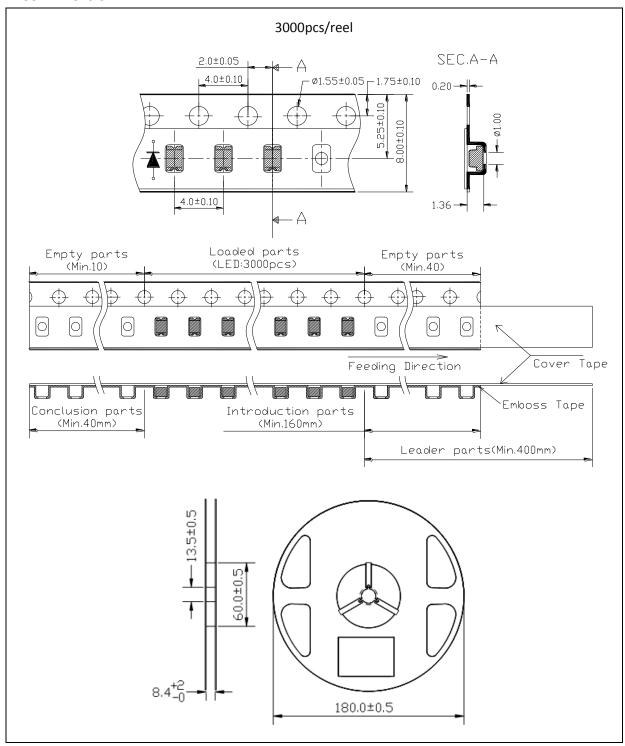
Note:

- 1. Recommend reflow temperature 245°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

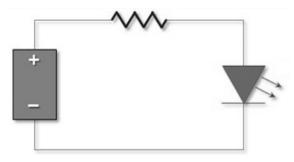
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	23/07/2014	Datasheet set-up.

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LT1ED53A AM27ZGC03 APFA3010SURKCGKQBDC APHK1608VGCA APT2012QGW CLX6D-FKB-CN1R1H1BB7D3D3 LTST
008BGEW LTW-010DCG LTW-020ZDCG LTW-21TS5 LTW-220DS5 598-8330-117F SML-LX0402IC-TR CMDA20AYAA7D1S

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CMD91-21VRC/TR7 SML-512PWT86A SMF-2432GYC-TR EASV3015RGYA0 LTST-C190KFKT-5A LTST-C194TBKT-5A CLX6E
FKC-CH1M1D1BB7C3D3 SML-LXL0805USBC-TR SML-LX2835SYSUGCTR LTW-M670ZVS-M5 APA2106ZGC/G CLMXB-FKA
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